

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/559923 Confirmation No. 1496
Applicant : Yoshinari Tsukada et al.
Filed : December 8, 2005
TC/A.U. : 2826
Examiner : Alexander O. Williams

Title : SEMICONDUCTOR DEVICE REDUCING WARPING
DUE TO HEAT PRODUCTION (as amended)
Docket No. : SHM-16366
Customer No. : 040854

REQUEST FOR SUPPLEMENTAL NOTICE OF ALLOWANCE

Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir/Madam:

In the "Notice of Allowance" that was mailed from the U.S. Patent and Trademark Office on September 8, 2008 for the above-identified application, there is an error in the "Title Of Invention". The title should read as follows:

Title Of Invention: SEMICONDUCTOR DEVICE REDUCING WARPING
DUE TO HEAT PRODUCTION

Applicant requests that a Supplemental Notice of Allowance be issued acknowledging the correct title in this application.

Respectfully submitted,

RANKIN, HILL, PORTER & CLARK LLP

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